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Intel® Core™ i7-6700K Processor (8M Cache, up to 4.20 GHz)

Specifications	
- Essentials	
Status	Launched
Launch Date	Q3'15
Processor Number	i7-6700K
Intel® Smart Cache	8 MB
DMI3	8 GT/s
Instruction Set	64-bit
Instruction Set Extensions	SSE4.1/4.2, AVX 2.0
Embedded Options Available	No No
Lithography	14 nm
Scalability	1S Only
Thermal Solution Specification	PCG 2015D (130W)
Recommended Customer Price	BOX : \$350.00 TRAY: \$339.00
Datasheet	Link
Product Brief	Link
- Performance	
# of Cores	4
# of Threads	8
Processor Base Frequency	4 GHz
Max Turbo Frequency	4.2 GHz
TDP	91 W
- Memory Specifications	
Max Memory Size (dependent on memory type)	64 GB
Max Memory Size (dependent on memory type) Memory Types	64 GB DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V
Memory Types	
	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V
Memory Types Max # of Memory Channels	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s
Memory Types Max # of Memory Channels Max Memory Bandwidth	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s
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Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported * - Graphics Specifications Processor Graphics * Graphics Base Frequency	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡ - Graphics Specifications Processor Graphics ‡	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡ - Graphics Specifications Processor Graphics ‡ Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Video Max Memory	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No Intel® HD Graphics 530 350 MHz 1.15 GHz 1.7 GB
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported * - Graphics Specifications Processor Graphics * Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Video Max Memory Graphics Output	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s Image: State of the state of
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡ - Graphics Specifications Processor Graphics ‡ Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Video Max Memory Graphics Output 4K Support	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No Intel® HD Graphics 530 350 MHz 1.15 GHz 1.7 GB eDP/DP/HDMI/DVI Yes, at 60Hz
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡ - Graphics Specifications Processor Graphics ‡ Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Video Max Memory Graphics Output 4K Support Max Resolution (Intel® WiDi)‡	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No Intel® HD Graphics 530 350 MHz 1.15 GHz 1.7 GB eDP/DP/HDMI/DVI Yes, at 60Hz 1080p
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡ - Graphics Specifications Processor Graphics ‡ Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Video Max Memory Graphics Output 4K Support Max Resolution (Intel® WiDi)‡ Max Resolution (HDMI 1.4)‡	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No Intel® HD Graphics 530 350 MHz 1.15 GHz 1.15 GHz eD/DP/HDMI/DVI Yes, at 60Hz 1080p 4096x2304@24Hz
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡ - Graphics Specifications Processor Graphics ‡ Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Video Max Memory Graphics Output 4K Support Max Resolution (Intel® WiDi)‡ Max Resolution (IDP)‡	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No Intel® HD Graphics 530 1.15 GHz 1.15 GHz 1.7 GB eDP/DP/HDMI/DVI Yes, at 60Hz 1080p 4096x2304@24Hz 4096x2304@60Hz
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported ‡ - Graphics Specifications Processor Graphics ‡ Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Video Max Memory Graphics Output 4K Support Max Resolution (Intel® WiDi)‡ Max Resolution (IDP)‡ Max Resolution (DP)‡	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s Image: Solution of the state st
Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported # - Graphics Specifications Processor Graphics # Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Output 4K Support Max Resolution (Intel® WiDi)# Max Resolution (IDDI 1.4)# Max Resolution (DP)# Max Resolution (VGA)#	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No Intel® HD Graphics 530 350 MHz 1.15 GHz 1.15 GHz PDPDP/HDMI/DVI Ves, at 60Hz 1080p 4096x2304@24Hz 4096x2304@60Hz
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Memory Types Max # of Memory Channels Max Memory Bandwidth ECC Memory Supported # - Graphics Specifications Processor Graphics # Graphics Base Frequency Graphics Max Dynamic Frequency Graphics Output 4K Support Max Resolution (Intel® WiDi)# Max Resolution (IDDI 1.4)# Max Resolution (DP)# Max Resolution (VGA)#	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V 2 34.1 GB/s No Image: Signal Sign
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Intel® Insider™ Intel® Wireless Display	Q	Yes	
Intel® Clear Video HD Technology	Yes		
Intel® Clear Video Technology	Yes		
# of Displays Supported [‡]		3	
Device ID		0x1912	
- Expansion Options			
PCI Express Revision		3.0	
PCI Express Configurations [‡]		Up to 1x16, 2x8, 1x8+2x4	
Max # of PCI Express Lanes		16	
- Package Specifications			
Max CPU Configuration		1	
Package Size		37.5mm x 37.5mm	
Graphics and IMC Lithography		14 nm	
Sockets Supported		FCLGA1151	
Low Halogen Options Available		See MDDS	
Advanced Technologia			
- Advanced Technologies		20	
Intel® Turbo Boost Technology *		2.0	
Intel® vPro Technology *	Q	No	
Intel® Hyper-Threading Technology *	٩	Yes	
Intel® Virtualization Technology (VT-x) *		Yes	
Intel® Virtualization Technology for Directed I/O (VT-d) #	Q	Yes	
Intel® VT-x with Extended Page Tables (EPT) *	Q	Yes	
Intel® TSX-NI		Yes	
Intel® 64 [±]	٩	Yes	
Idle States		Yes	
Enhanced Intel SpeedStep® Technology	٩	Yes	
Thermal Monitoring Technologies		Yes	
Intel® Identity Protection Technology ‡		Yes	
ntel® Stable Image Platform Program (SIPP)		No	
Intel® Small Business Advantage		Yes	
- Intel® Data Protection Technology			
Intel® AES New Instructions	Q	Yes	
Secure Key		Yes	
- Intel® Platform Protection Technology			
OS Guard		Yes	
Trusted Execution Technology [‡]	Q	No	
Execute Disable Bit [‡]		Yes	

Compatible Products

Find Compatible Desktop Boards >

- Chipsets						
Compare Compare All +	Product Name	Status	Embedded Options Available	TDP	Recommended Customer Price	
	Intel® H170 Chipset (Intel® GL82H170 PCH)	Announced	No	6 W	N/A	
		Announced	Yes	6 W	N/A	

Compare	Product Name	Status	Embedded Options Available	TDP	Recommended Customer Pric
Compare All +					
	Intel® H110 Chipset (Intel® GL82H110 PCH)				
	Intel® Z170 Chipset (Intel® GL82Z170 PCH)	Launched	No	6 W	T&R:\$47.00
	Intel® Q170 Chipset (Intel® GL82Q170 PCH)	Announced	Yes	6 W	N/A
	Intel [®] Q150 Chipset (Intel [®] GL82Q150 PCH)	Announced	No	6 W	N/A
	Intel® B150 Chipset (Intel® GL82B150 PCH)	Announced	No	6 W	N/A

Ordering and Spec Information

Trade Compliance Information

ECCN	CCATS
5A992C	G077159

Ordering and Spec Information

Spec Code	Ordering Code	Step	US HTS	RCP		
Boxed Intel® Core™ i7-6700K Processor (8M Cache, up to 4.20 GHz) FC-LGA14C						
SR2BR	BX80662176700K	RO	8542310000	\$350.00		
Intel® Core™ i7-6700K Processor (8M Cache, up to 4.20 GHz) FC-LGA14C, Tray						
SR2BR	CM8066201919901	RO	8542310000-HYBRD	\$339.00		

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update.

[‡] This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading/hyper-threading-technology.html?wapkw=hyper+threading for more information including details on which processors support Intel* HT Technology.

Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel[®] Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

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System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see http://www.intel.com/performance.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See http://www.intel.com/content/www/us/en/processors/processor-numbers.html for details.

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

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